## **DISCRETE SEMICONDUCTORS**

# DATA SHEET

## BTA212 series D, E and F Three quadrant triacs guaranteed commutation

**Product specification** 

September 2018



## Three quadrant triacs guaranteed commutation

## BTA212 series D, E and F

### **GENERAL DESCRIPTION**

Passivated guaranteed commutation triacs in a plastic envelope intended for use in motor control circuits or with other highly inductive loads. These devices balance the requirements of commutation performance and gate sensitivity. The "sensitive gate" E series and "logic level" D series are intended for interfacing with low power drivers, including micro controllers.

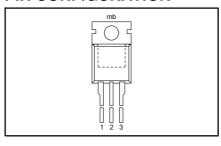
### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	MAX.	UNIT
	BTA212- BTA212- BTA212-	600D 600E 600F	
$V_{DRM}$	Repetitive peak off-state	600	V
I <sub>T(RMS)</sub> I <sub>TSM</sub>	voltages RMS on-state current Non-repetitive peak on-state current	12 95	A A

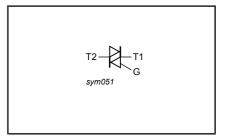
### **PINNING - TO220AB**

PIN	DESCRIPTION
1	main terminal 1
2	main terminal 2
3	gate
tab	main terminal 2

### PIN CONFIGURATION



### **SYMBOL**



### LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{DRM}$	Repetitive peak off-state voltages		-	600¹	v
I <sub>T(RMS)</sub>	RMS on-state current Non-repetitive peak	full sine wave; $T_{mb} \le 99 ^{\circ}C$ full sine wave;	-	12	А
I <sup>2</sup> t dI <sub>T</sub> /dt	on-state current  I <sup>2</sup> t for fusing Repetitive rate of rise of on-state current after	$T_j$ = 25 °C prior to surge t = 20 ms t = 16.7 ms t = 10 ms $I_{TM}$ = 20 A; $I_G$ = 0.2 A; $dI_G/dt$ = 0.2 Å/ $\mu$ s		95 105 45 100	Α Α Α²s Α/μs
$\begin{matrix} I_{GM} \\ P_{GM} \\ P_{G(AV)} \end{matrix}$	triggering Peak gate current Peak gate power Average gate power Storage temperature Operating junction temperature	over any 20 ms period	- - -40 -	2 5 0.5 150 125	A W C C

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<sup>1</sup> Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 15  $A/\mu s$ .

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### THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{\text{th j-mb}}$ $R_{\text{th j-a}}$	Thermal resistance junction to mounting base Thermal resistance junction to ambient	full cycle half cycle in free air	1 1 1	- - 60	1.5 2.0 -	K/W K/W K/W

### STATIC CHARACTERISTICS

T<sub>i</sub> = 25 °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.		MAX.		UNIT
		BTA212-		D	Е	F	
I <sub>GT</sub>	Gate trigger current <sup>2</sup>	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}$					
".		T2+ G+	-	5 5 5	10	25	mA
		T2+ G-	-	5	10	25	mA
١.	l	T2- G-	-	5	10	25	mA
l <sub>L</sub>	Latching current	$V_{D} = 12 \text{ V}; I_{GT} = 0.1 \text{ A}$					
		T2+ G+	-	15	20	25	mA
		T2+ G-	-	25	30	40	mA
		T2- G-	-	25	30	40	mA
I <sub>H</sub>	Holding current	$V_D = 12 \text{ V}; I_{GT} = 0.1 \text{ A}$	-	15	25	30	mA
$V_{T}$	On-state voltage	$I_{T} = 17 \text{ A}$	_		1.6		V
V <sub>GT</sub>	Gate trigger voltage	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}$	_		1.5		V
		$V_D = 400 \text{ V}; I_T = 0.1 \text{ A};$	0.25		-		V
1.		$T_{j} = 125 ^{\circ}\text{C}$			٥.		
I <sub>D</sub>	Off-state leakage current	$V_D = V_{DRM(max)}$ ; $T_j = 125  ^{\circ}C$	-		0.5		mA

### **DYNAMIC CHARACTERISTICS**

T<sub>i</sub> = 25 °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.			MAX.	UNIT
		BTA212-	D	Е	F		
dV <sub>D</sub> /dt	Critical rate of rise of off-state voltage	V <sub>DM</sub> = 67% V <sub>DRM(max)</sub> ; T <sub>j</sub> = 110 °C; exponential waveform; gate open circuit	30	60	70	-	V/μs
dI <sub>com</sub> /dt	Critical rate of change of commutating current	$V_{DM} = 400 \text{ V; } T_j = 125 \text{ °C;}$ $I_{T(RMS)} = 12 \text{ A;}$ $dV_{com}/dt = 10 \text{ V/}\mu\text{s; gate}$ open circuit	1.0	8	21	-	A/ms
dI <sub>com</sub> /dt	Critical rate of change of commutating current	$\begin{array}{l} V_{DM} = 400 \text{ V; } T_j = 125 \text{ °C;} \\ I_{T(RMS)} = 12 \text{ A;} \\ dV_{com}/dt = 0.1 \text{ V/}\mu\text{s; gate} \\ open circuit \end{array}$	3.5	16	32	1	A/ms

<sup>2</sup> Device does not trigger in the T2-, G+ quadrant.

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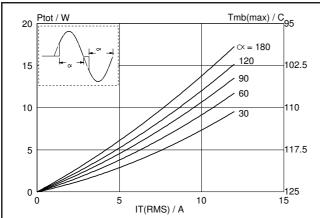


Fig.1. Maximum on-state dissipation,  $P_{tot}$ , versus rms on-state current,  $I_{T(RMS)}$ , where  $\alpha$  = conduction angle.

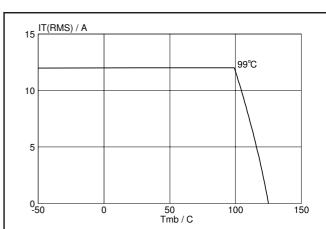


Fig.4. Maximum permissible rms current  $I_{T(RMS)}$ , versus mounting base temperature  $T_{mb}$ .

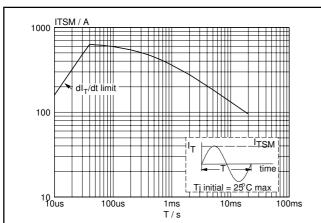


Fig.2. Maximum permissible non-repetitive peak on-state current  $I_{TSM}$ , versus pulse width  $t_p$ , for sinusoidal currents,  $t_p \le 20$ ms.

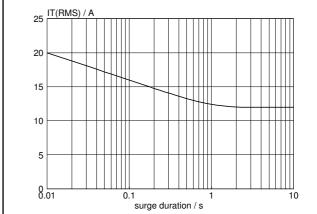


Fig.5. Maximum permissible repetitive rms on-state current  $I_{T(RMS)}$ , versus surge duration, for sinusoidal currents, f = 50 Hz;  $T_{mb} \le 99$ °C.

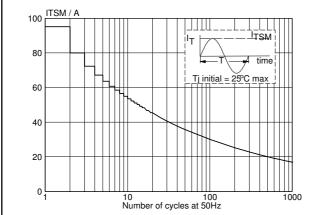


Fig.3. Maximum permissible non-repetitive peak on-state current  $I_{TSM}$ , versus number of cycles, for sinusoidal currents, f = 50 Hz.

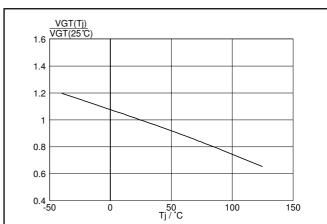
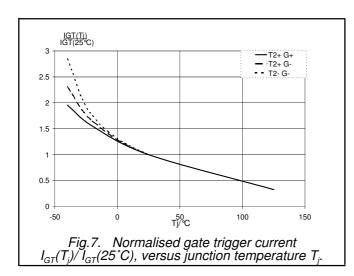


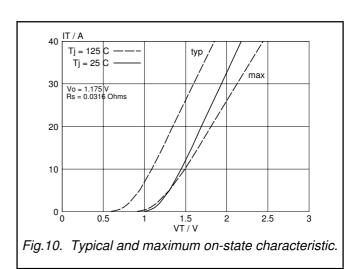
Fig.6. Normalised gate trigger voltage  $V_{GT}(T_j)/V_{GT}(25^{\circ}C)$ , versus junction temperature  $T_{j}$ .

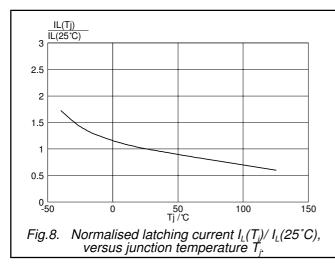
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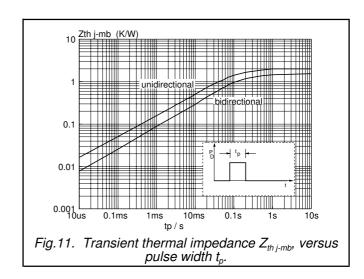
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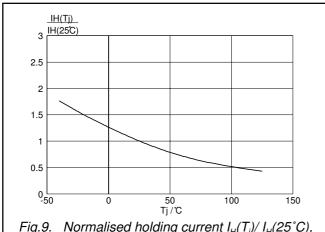
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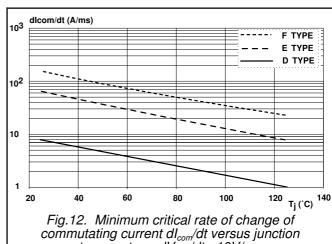


Fig.9. Normalised holding current  $I_H(T_i)/I_H(25^{\circ}C)$ , versus junction temperature  $T_i$ .

Fig.12. Minimum critical rate of change of commutating current  $dI_{com}/dt$  versus junction temperature,  $dV_{com}/dt = 10V/\mu s$ .

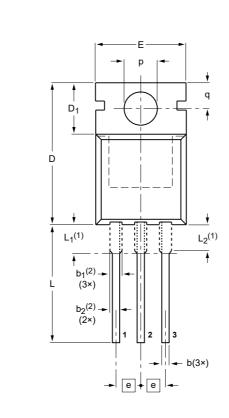
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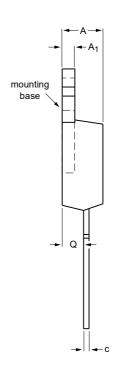
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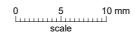
### **MECHANICAL DATA**

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB

SOT78







### **DIMENSIONS** (mm are the original dimensions)

UNIT	Α	A <sub>1</sub>	b	b <sub>1</sub> <sup>(2)</sup>	b <sub>2</sub> <sup>(2)</sup>	U	D	D <sub>1</sub>	E	е	L	L <sub>1</sub> <sup>(1)</sup>	L <sub>2</sub> <sup>(1)</sup> max.	р	q	q
mm	4.7 4.1	1.40 1.25	0.9 0.6	1.6 1.0	1.3 1.0	0.7 0.4	16.0 15.2	6.6 5.9	10.3 9.7	2.54	15.0 12.8	3.30 2.79	3.0	3.8 3.5	3.0 2.7	2.6 2.2

#### Notes

- Lead shoulder designs may vary.
- 2. Dimension includes excess dambar.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	IEC JEDEC JEIT			PROJECTION	ISSUE DATE
SOT78		3-lead TO-220AB	SC-46			<del>08-04-23</del> 08-06-13

### Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition				
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.				
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Product [short] data sheet	Production	This document contains the product specification.				

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